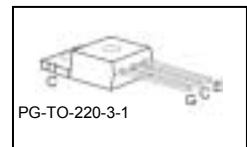
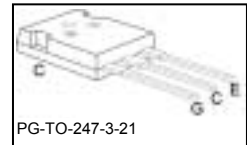
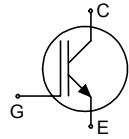


## Fast IGBT in NPT-technology

- 75% lower  $E_{off}$  compared to previous generation combined with low conduction losses
- Short circuit withstand time – 10  $\mu$ s
- Designed for:
  - Motor controls
  - Inverter
- NPT-Technology for 600V applications offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behaviour
  - parallel switching capability
- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



Type	$V_{CE}$	$I_C$	$V_{CE(sat)}$	$T_j$	Marking	Package
SGP10N60A	600V	10A	2.3V	150°C	G10N60A	PG-TO-220-3-1
SGW10N60A	600V	10A	2.3V	150°C	G10N60A	PG-TO-247-3-21

### Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CE}$	600	V
DC collector current	$I_C$	20	A
$T_C = 25^\circ\text{C}$		10.6	
$T_C = 100^\circ\text{C}$			
Pulsed collector current, $t_p$ limited by $T_{jmax}$	$I_{Cpuls}$	40	
Turn off safe operating area $V_{CE} \leq 600\text{V}$ , $T_j \leq 150^\circ\text{C}$	-	40	
Gate-emitter voltage	$V_{GE}$	$\pm 20$	V
Avalanche energy, single pulse $I_C = 10\text{ A}$ , $V_{CC} = 50\text{ V}$ , $R_{GE} = 25\ \Omega$ , start at $T_j = 25^\circ\text{C}$	$E_{AS}$	70	mJ
Short circuit withstand time <sup>2</sup> $V_{GE} = 15\text{V}$ , $V_{CC} \leq 600\text{V}$ , $T_j \leq 150^\circ\text{C}$	$t_{SC}$	10	$\mu$ s
Power dissipation $T_C = 25^\circ\text{C}$	$P_{tot}$	92	W
Operating junction and storage temperature	$T_j$ , $T_{stg}$	-55...+150	$^\circ\text{C}$
Soldering temperature, wavesoldering, 1.6mm (0.063 in.) from case for 10s	$T_s$	260	

<sup>1</sup> J-STD-020 and JESD-022

<sup>2</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

### Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
<b>Characteristic</b>				
IGBT thermal resistance, junction – case	$R_{thJC}$		1.35	K/W
Thermal resistance, junction – ambient	$R_{thJA}$	PG-TO-220-3-1 PG-TO-247-3-21	62 40	

### Electrical Characteristic, at $T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
<b>Static Characteristic</b>						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_C=500\mu A$	600	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE} = 15V, I_C=10A$ $T_j=25^\circ C$ $T_j=150^\circ C$	1.7 -	2 2.3	2.4 2.8	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=300\mu A, V_{CE}=V_{GE}$	3	4	5	
Zero gate voltage collector current	$I_{CES}$	$V_{CE}=600V, V_{GE}=0V$ $T_j=25^\circ C$ $T_j=150^\circ C$	- -	- -	40 1500	$\mu A$
Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=20V$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{CE}=20V, I_C=10A$	-	6.7	-	S
<b>Dynamic Characteristic</b>						
Input capacitance	$C_{iss}$	$V_{CE}=25V,$	-	550	660	pF
Output capacitance	$C_{oss}$	$V_{GE}=0V,$	-	62	75	
Reverse transfer capacitance	$C_{riss}$	$f=1MHz$	-	42	51	
Gate charge	$Q_{Gate}$	$V_{CC}=480V, I_C=10A$ $V_{GE}=15V$	-	52	68	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$	PG-TO-220-3-1 PG-TO-247-3-21	- -	7 13	- -	nH
Short circuit collector current <sup>2)</sup>	$I_{C(SC)}$	$V_{GE}=15V, t_{SC}\leq 10\mu s$ $V_{CC}\leq 600V,$ $T_j\leq 150^\circ C$	-	100	-	A

<sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

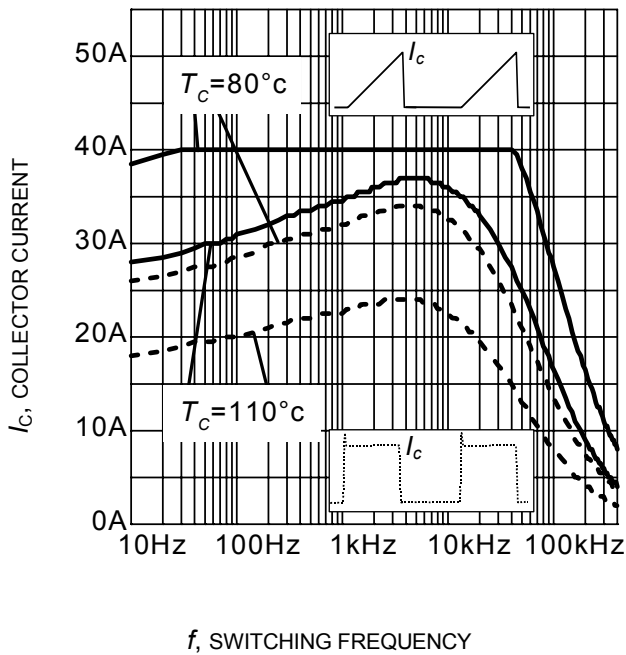
### Switching Characteristic, Inductive Load, at $T_j=25^\circ\text{C}$

Parameter	Symbol	Conditions	Value			Unit	
			min.	typ.	max.		
<b>IGBT Characteristic</b>							
Turn-on delay time	$t_{d(on)}$	$T_j=25^\circ\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=10\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=25\Omega$ , $L_{\sigma}^{(1)}=180\text{nH}$ , $C_{\sigma}^{(1)}=55\text{pF}$	-	28	34	ns	
Rise time	$t_r$		-	12	15		
Turn-off delay time	$t_{d(off)}$		-	178	214		
Fall time	$t_f$		-	24	29		
Turn-on energy	$E_{on}$		Energy losses include "tail" and diode reverse recovery.	-	0.15	0.173	mJ
Turn-off energy	$E_{off}$			-	0.17	0.221	
Total switching energy	$E_{ts}$			-	0.320	0.394	

### Switching Characteristic, Inductive Load, at $T_j=150^\circ\text{C}$

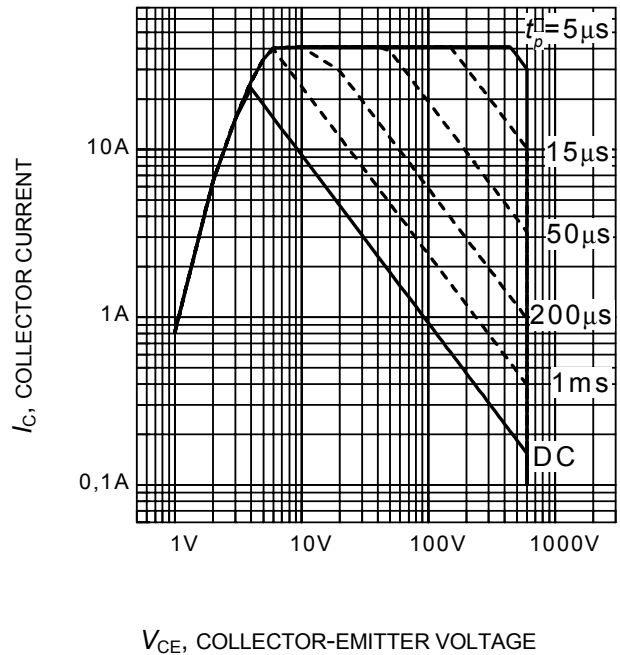
Parameter	Symbol	Conditions	Value			Unit	
			min.	typ.	max.		
<b>IGBT Characteristic</b>							
Turn-on delay time	$t_{d(on)}$	$T_j=150^\circ\text{C}$ $V_{CC}=400\text{V}$ , $I_C=10\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=25\Omega$ $L_{\sigma}^{(1)}=180\text{nH}$ , $C_{\sigma}^{(1)}=55\text{pF}$	-	28	34	ns	
Rise time	$t_r$		-	12	15		
Turn-off delay time	$t_{d(off)}$		-	198	238		
Fall time	$t_f$		-	26	32		
Turn-on energy	$E_{on}$		Energy losses include "tail" and diode reverse recovery.	-	0.260	0.299	mJ
Turn-off energy	$E_{off}$			-	0.280	0.364	
Total switching energy	$E_{ts}$			-	0.540	0.663	

<sup>1)</sup> Leakage inductance  $L_{\sigma}$  and Stray capacity  $C_{\sigma}$  due to dynamic test circuit in Figure E.



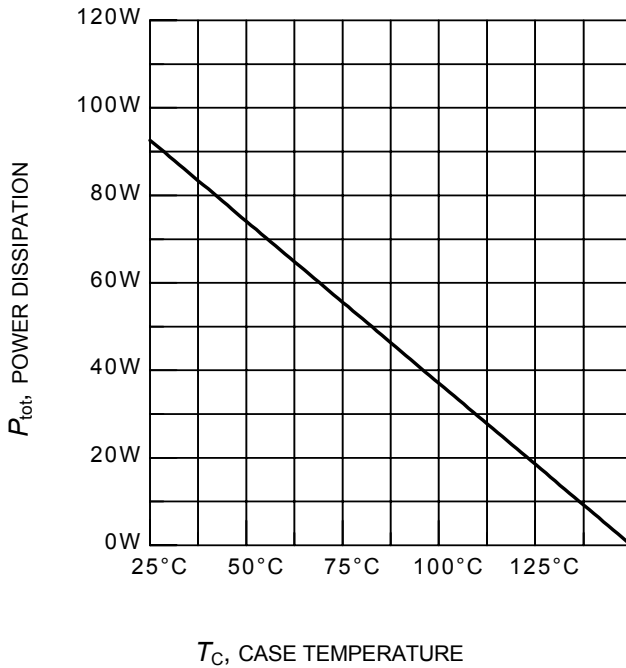
$f$ , SWITCHING FREQUENCY

**Figure 1. Collector current as a function of switching frequency**  
 ( $T_j \leq 150^\circ\text{C}$ ,  $D = 0.5$ ,  $V_{CE} = 400\text{V}$ ,  
 $V_{GE} = 0/+15\text{V}$ ,  $R_G = 25\Omega$ )



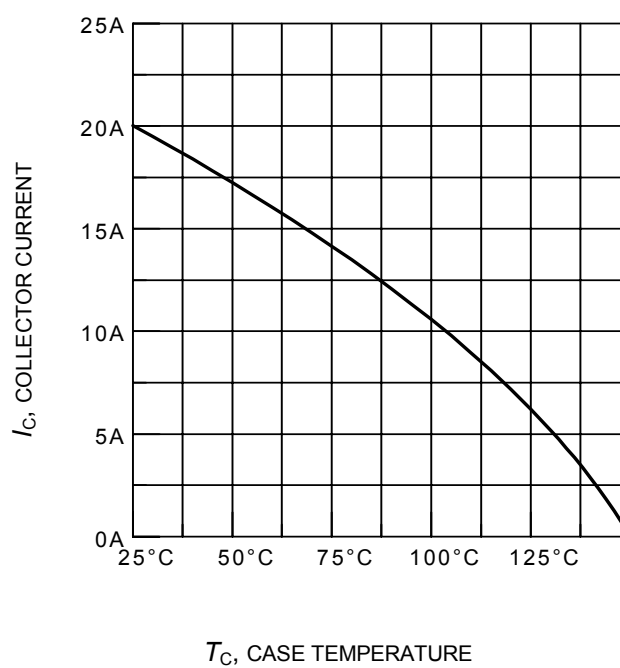
$V_{CE}$ , COLLECTOR-EMITTER VOLTAGE

**Figure 2. Safe operating area**  
 ( $D = 0$ ,  $T_C = 25^\circ\text{C}$ ,  $T_j \leq 150^\circ\text{C}$ )



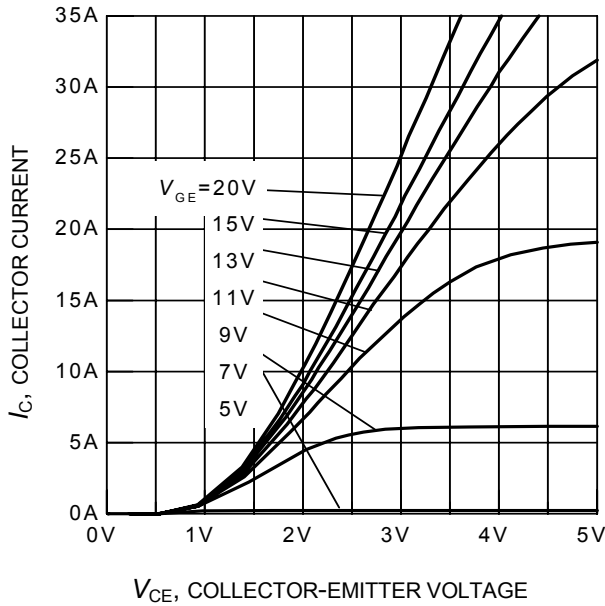
$T_C$ , CASE TEMPERATURE

**Figure 3. Power dissipation as a function of case temperature**  
 ( $T_j \leq 150^\circ\text{C}$ )

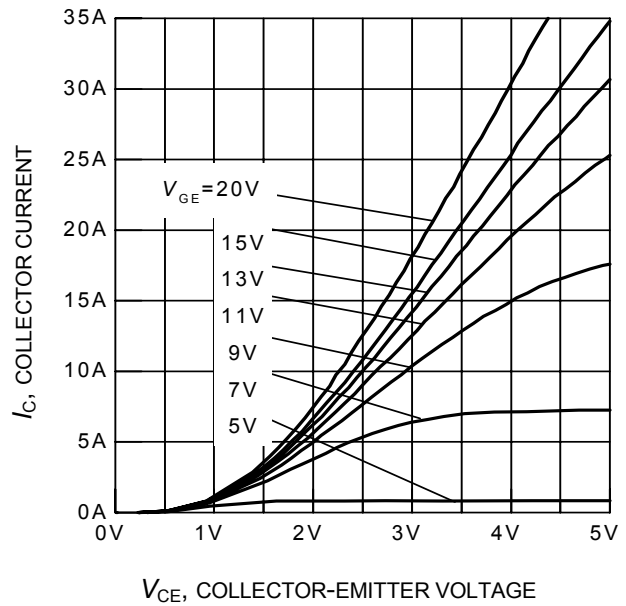


$T_C$ , CASE TEMPERATURE

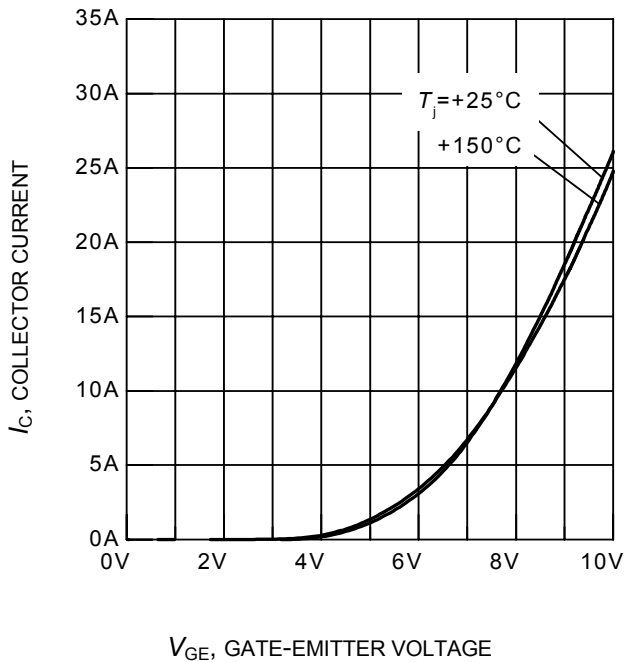
**Figure 4. Collector current as a function of case temperature**  
 ( $V_{GE} \leq 15\text{V}$ ,  $T_j \leq 150^\circ\text{C}$ )



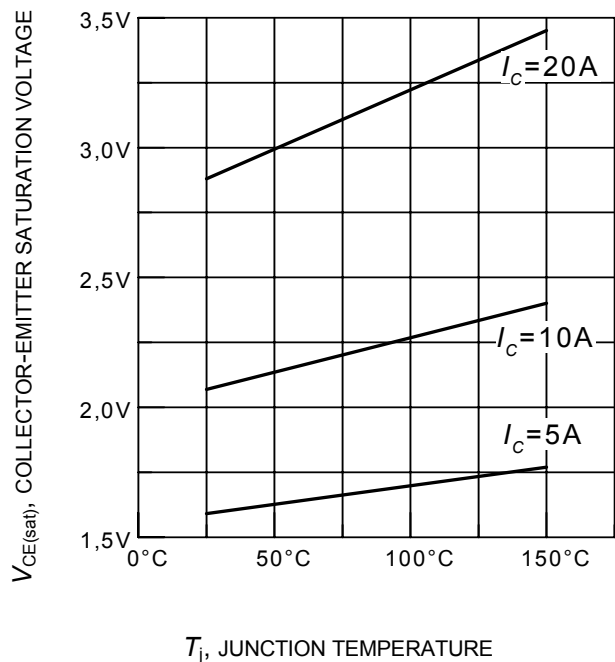
**Figure 5. Typical output characteristics**  
( $T_j = 25^\circ\text{C}$ )



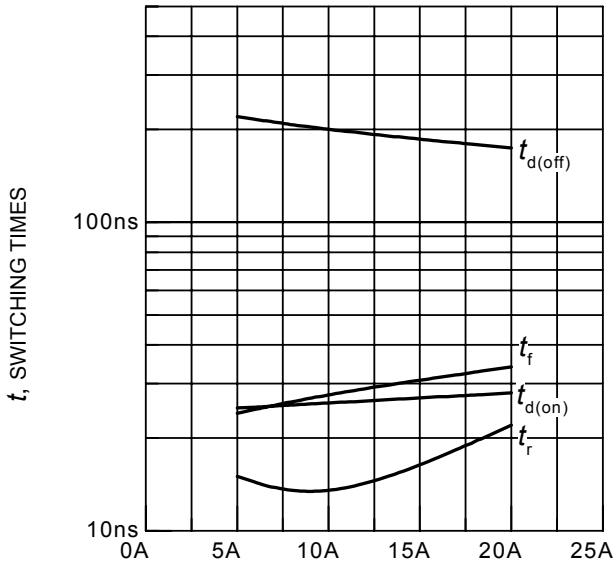
**Figure 6. Typical output characteristics**  
( $T_j = 150^\circ\text{C}$ )



**Figure 7. Typical transfer characteristics**  
( $V_{CE} = 10\text{V}$ )



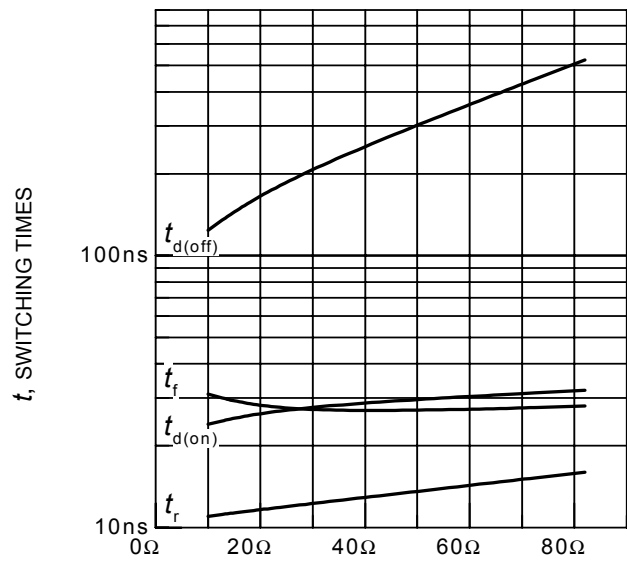
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



$I_C$ , COLLECTOR CURRENT

**Figure 9. Typical switching times as a function of collector current**

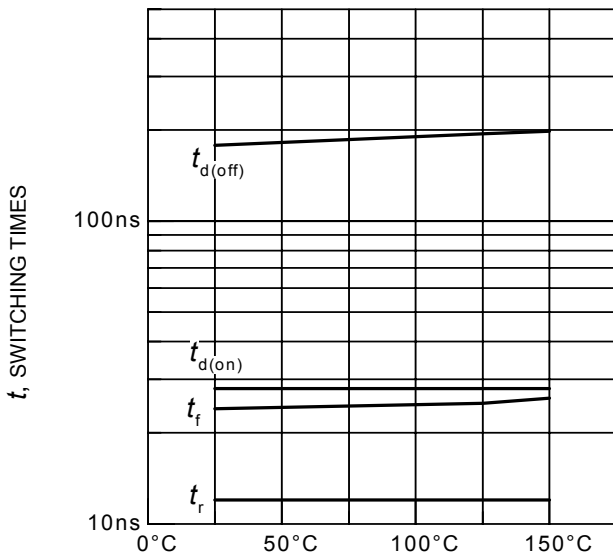
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $R_G = 25\Omega$ , Dynamic test circuit in Figure E)



$R_G$ , GATE RESISTOR

**Figure 10. Typical switching times as a function of gate resistor**

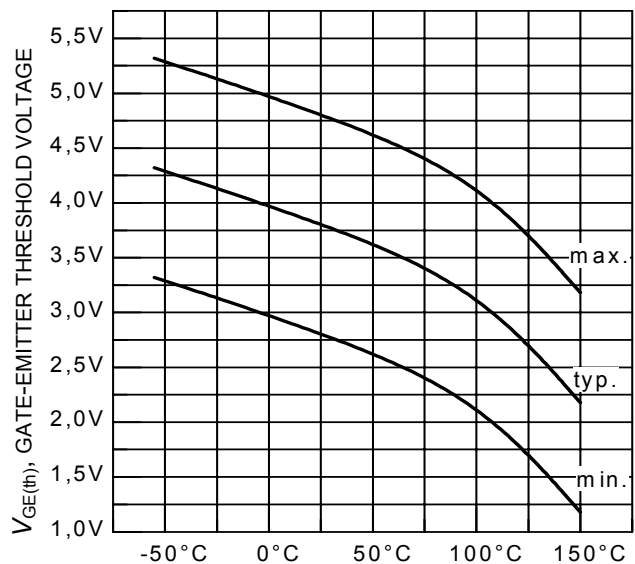
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 10\text{A}$ , Dynamic test circuit in Figure E)



$T_j$ , JUNCTION TEMPERATURE

**Figure 11. Typical switching times as a function of junction temperature**

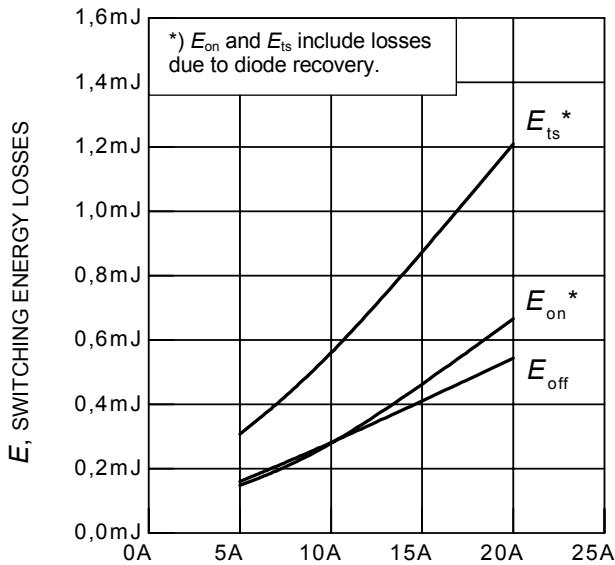
(inductive load,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 10\text{A}$ ,  $R_G = 25\Omega$ , Dynamic test circuit in Figure E)



$T_j$ , JUNCTION TEMPERATURE

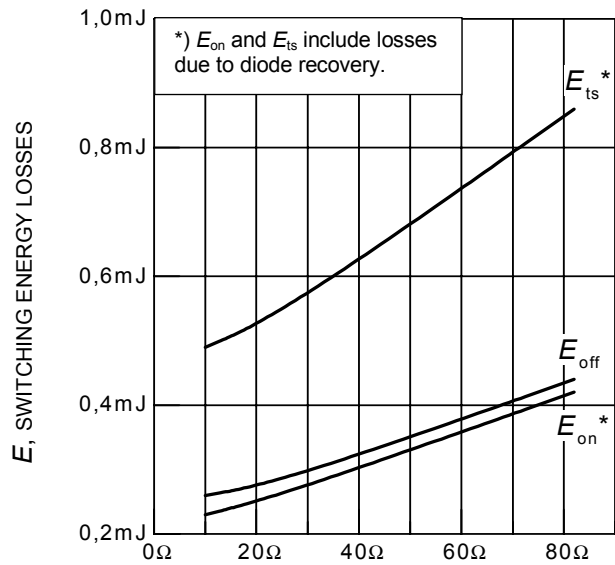
**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**

( $I_C = 0.3\text{mA}$ )



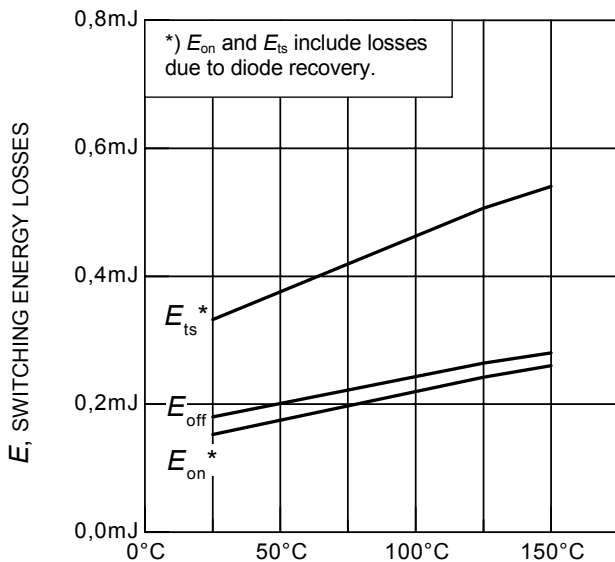
$I_C$ , COLLECTOR CURRENT

**Figure 13. Typical switching energy losses as a function of collector current**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $R_G = 25\Omega$ , Dynamic test circuit in Figure E)



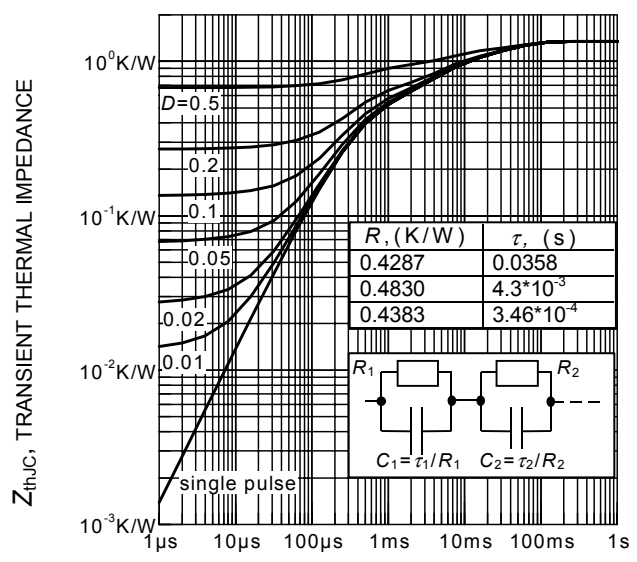
$R_G$ , GATE RESISTOR

**Figure 14. Typical switching energy losses as a function of gate resistor**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 10\text{A}$ , Dynamic test circuit in Figure E)



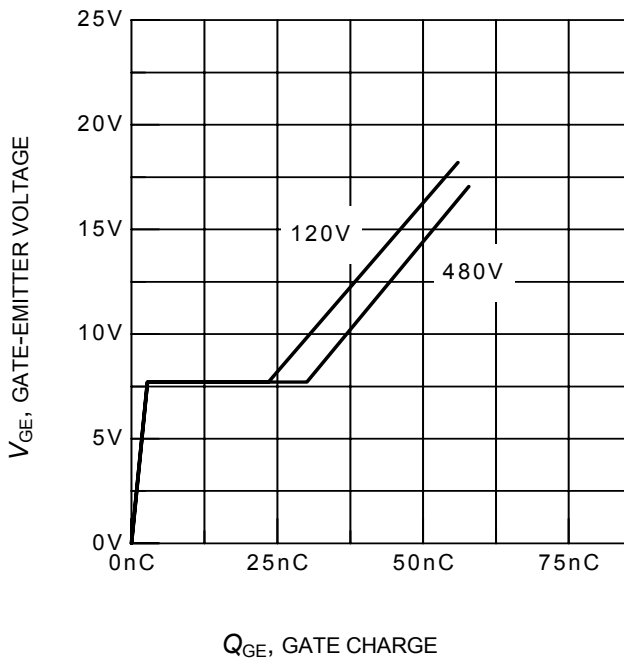
$T_j$ , JUNCTION TEMPERATURE

**Figure 15. Typical switching energy losses as a function of junction temperature**  
(inductive load,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 10\text{A}$ ,  $R_G = 25\Omega$ , Dynamic test circuit in Figure E)

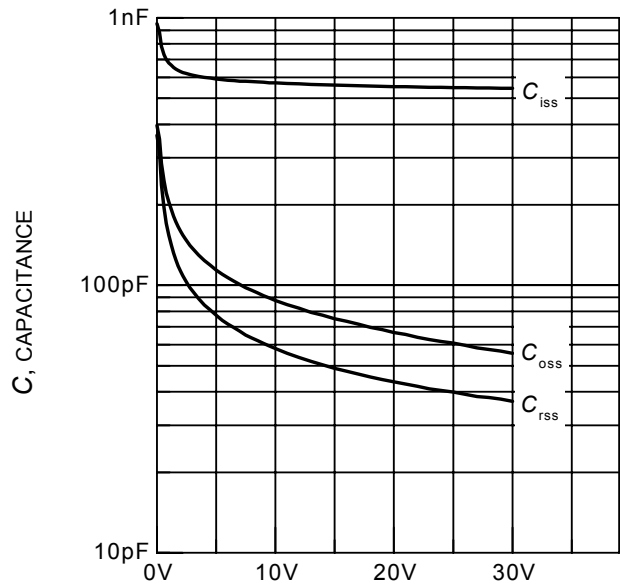


$t_p$ , PULSE WIDTH

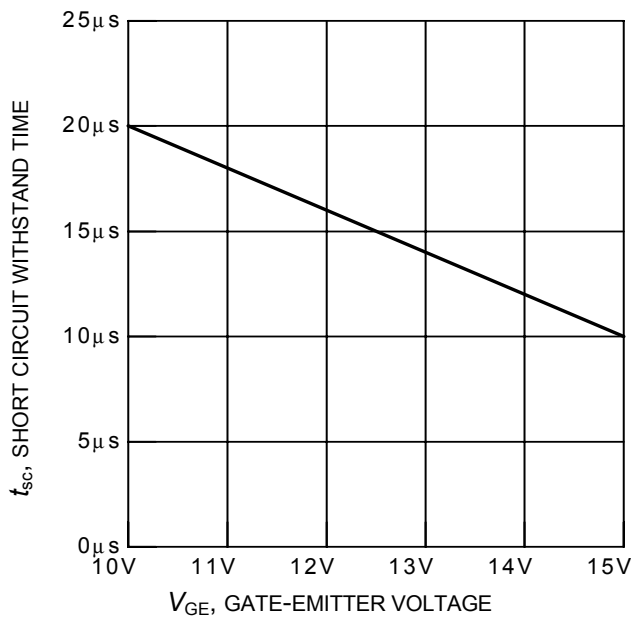
**Figure 16. IGBT transient thermal impedance as a function of pulse width**  
( $D = t_p / T$ )



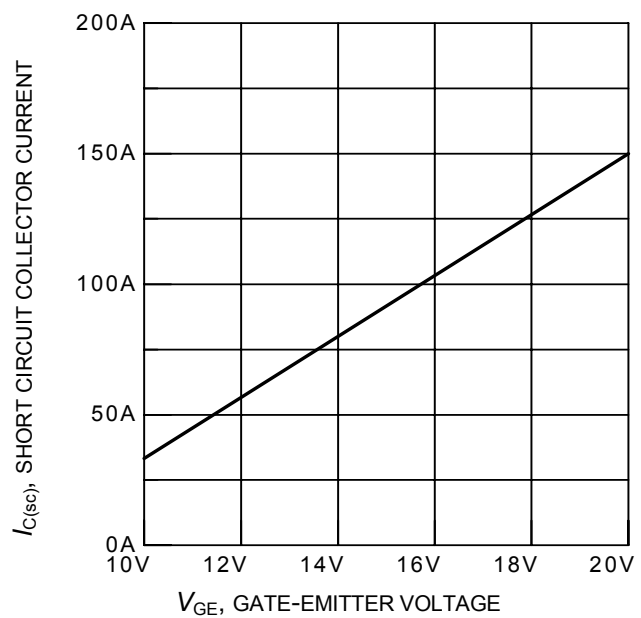
$Q_{GE}$ , GATE CHARGE  
**Figure 17. Typical gate charge**  
( $I_C = 10A$ )



$V_{CE}$ , COLLECTOR-EMITTER VOLTAGE  
**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE} = 0V, f = 1MHz$ )



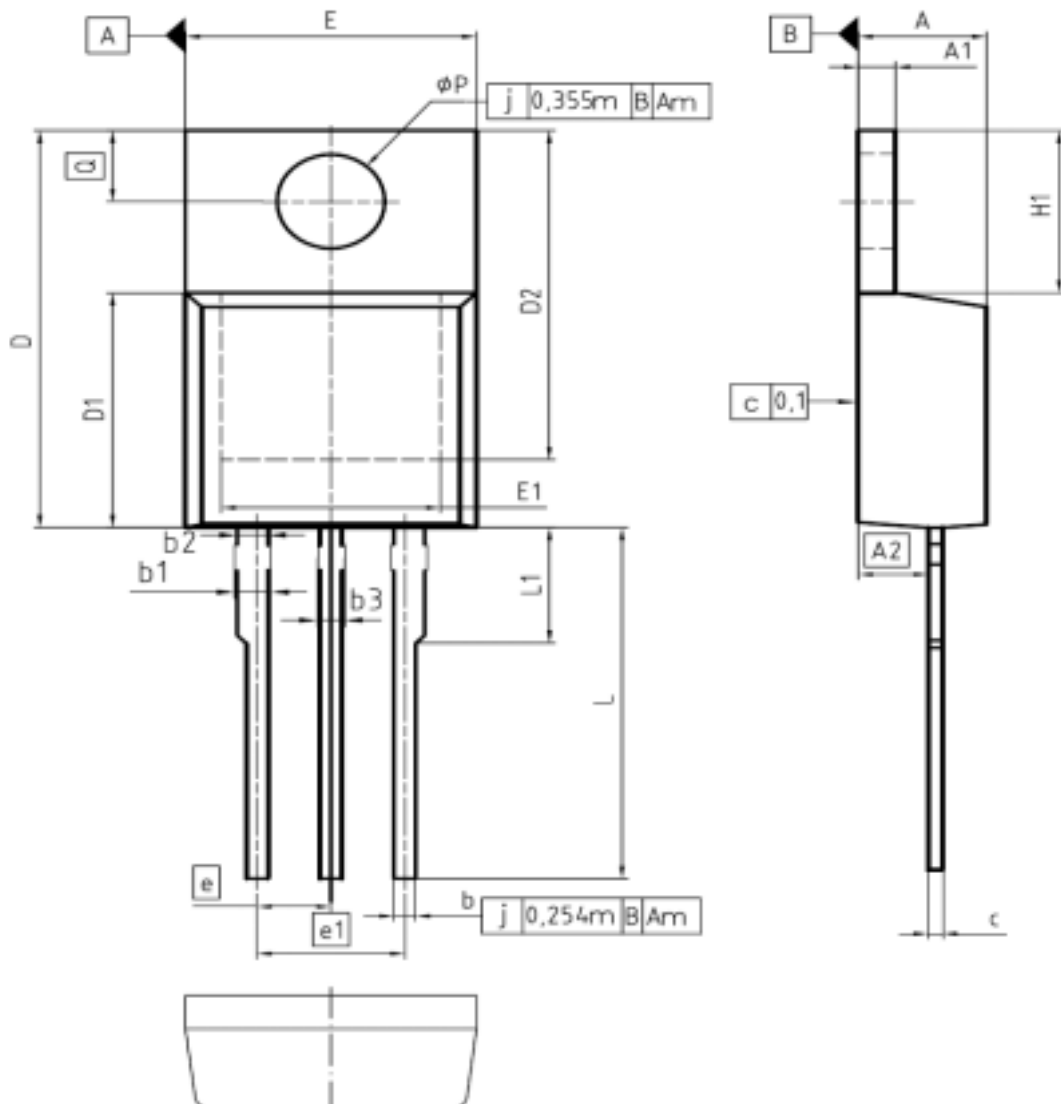
$t_{sc}$ , SHORT CIRCUIT WITHSTAND TIME  
 $V_{GE}$ , GATE-EMITTER VOLTAGE  
**Figure 19. Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE} = 600V, \text{start at } T_j = 25^\circ C$ )



$I_{C(sc)}$ , SHORT CIRCUIT COLLECTOR CURRENT  
 $V_{GE}$ , GATE-EMITTER VOLTAGE  
**Figure 20. Typical short circuit collector current as a function of gate-emitter voltage**  
( $V_{CE} \leq 600V, T_j = 150^\circ C$ )



PG-TO220-3-1



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	1.17	1.40	0.046	0.055
A2	2.15	2.72	0.085	0.107
b	0.65	0.86	0.026	0.034
b1	0.95	1.40	0.037	0.055
b2	0.95	1.15	0.037	0.045
b3	0.65	1.15	0.026	0.045
c	0.33	0.60	0.013	0.024
D	14.81	15.95	0.583	0.628
D1	8.51	9.45	0.335	0.372
D2	12.19	13.10	0.480	0.516
E	9.70	10.36	0.382	0.408
E1	6.50	8.60	0.256	0.339
e	2.54		0.100	
e1	5.08		0.200	
N	3		3	
H1	5.90	6.90	0.232	0.272
L	13.00	14.00	0.512	0.551
L1	-	4.80	-	0.189
phi P	3.60	3.89	0.142	0.153
Q	2.60	3.00	0.102	0.118

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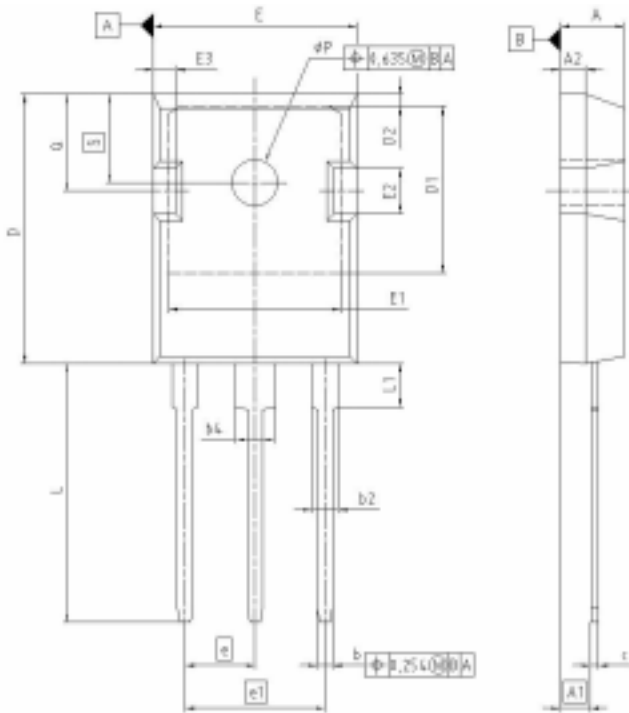
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EUROPEAN PROJECTION

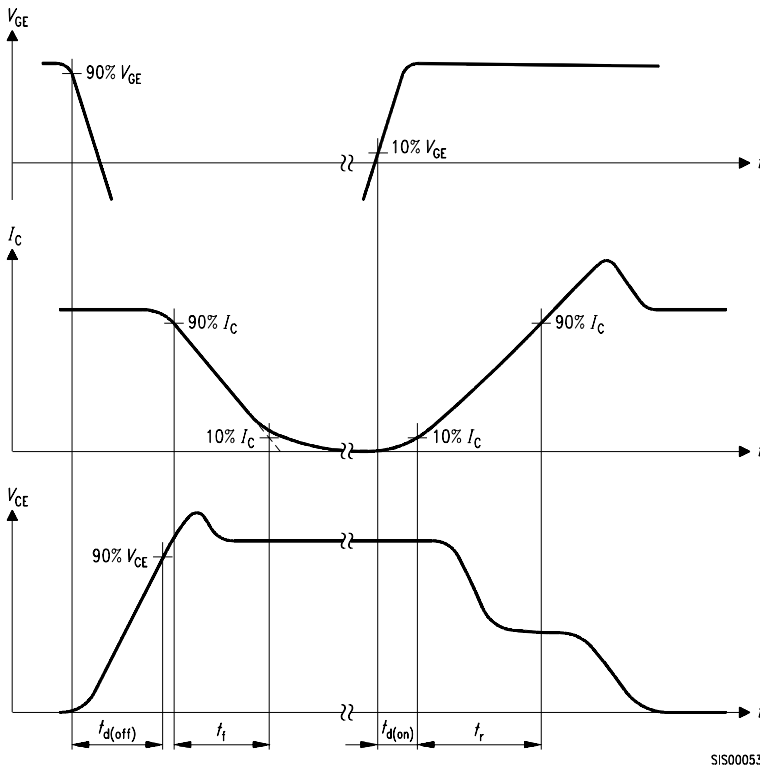
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REVISION  
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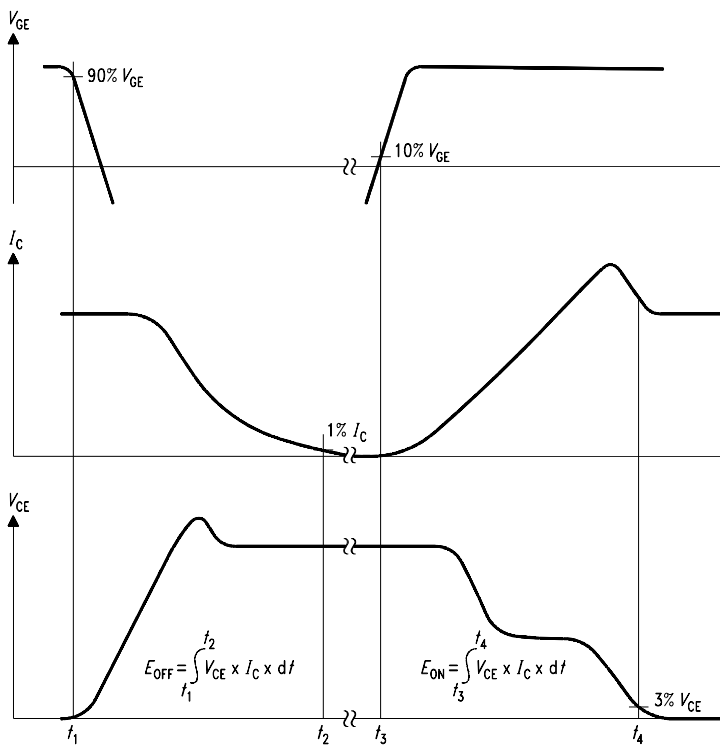
PG-TO247-3-21



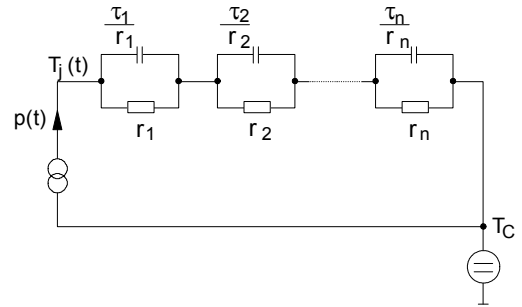
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.803	5.157	0.193	0.203
A1	2.273	2.527	0.092	0.099
A2	1.653	2.107	0.075	0.081
b	1.073	1.327	0.047	0.052
b1	1.903	2.388	0.075	0.094
b2	2.870	3.454	0.113	0.136
b4	0.549	0.752	0.021	0.030
c	20.823	21.077	0.820	0.830
D	17.323	17.831	0.682	0.702
D1	1.063	1.317	0.042	0.052
D2	15.773	16.027	0.621	0.631
E	13.893	14.147	0.547	0.557
E1	3.683	3.057	0.145	0.158
E2	1.803	1.907	0.069	0.076
e	5.450		0.215	
e1	10.000		0.430	
N	3		3	
L	20.953	20.307	0.789	0.799
L1	4.166	4.472	0.164	0.176
pP	3.259	3.261	0.140	0.144
Q	5.405	5.747	0.215	0.228
S	6.043	6.297	0.238	0.248



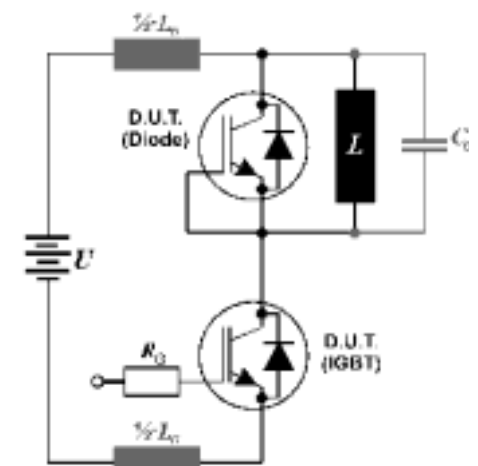
**Figure A. Definition of switching times**



**Figure B. Definition of switching losses**



**Figure D. Thermal equivalent circuit**



**Figure E. Dynamic test circuit**  
Leakage inductance  $L_{\sigma} = 180\text{nH}$   
and Stray capacity  $C_{\sigma} = 55\text{pF}$ .

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